TOSHIBA BIPOLAR LINEAR INTEGRATED CIRCUIT SILICON MONOLITHIC

# TA8214K

# **MULTI OUTPUT VOLTAGE REGULATOR (8.3V OUTPUT)**

The TA8214K is voltage regulator IC, designed for car audio use, has built-in 4 outputs. (Fixed 1 output and changed 3 outputs.)

The input-output differential voltage: VDIF is very small.  $(V_{DIF} = 0.3V (Typ.))$ 

Because each outputs consist of PNP Transistor. In addition, protection of over voltage, output short and thermal shut down are involved.



Weight: 2.19g (Typ.)

#### **FEATURES**

• 4 Channel Outputs

OUT1: 8.3V (Typ.) / 100mA (Max.) .... Fixed Output

OUT2: 8.3V (Typ.) / 100mA (Max.)

OUT3: 8.3V (Typ.)/300mA (Max.) >Switchable Output

OUT4: 8.3V (Typ.) / 100mA (Max.)

Very Small Input-Output Differential Voltage

 $V_{DIF} = 0.3V \text{ (Typ.)}$ 

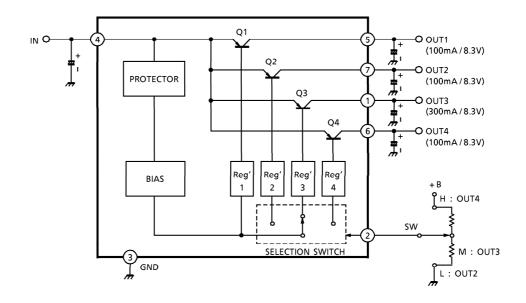
 Built-in Various Protection Circuits Over Voltage, Output Short, Thermal Shut Down

WWW.DZSC.COM Input Operating Voltage

 $V_{IN (opr)} = 9.3 \sim 18V$ 



### **BLOCK DIAGRAM**



#### **CAUTION FOR USE AND METHOD OF APPLICATION**

(1) IC protective diode in  $V_{IN} < V_{OUT}$  mode : D

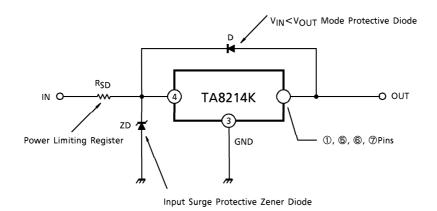
When surge voltage is applied to the input/output terminals of IC or  $V_{OUT}$  becomes larger than  $V_{IN}$  ( $V_{IN}$ < $V_{OUT}$ ) at the time of power ON/OFF, insert a high speed switching diode : D.

(2) Power limiting register: RSD

If V<sub>IN</sub> is too high, insert a power limiting register: R<sub>SD</sub> to reduce power dissipation of IC.

(3) Input surge protective Zener diode: ZD

Though an over voltage protective circuit (For positive surge) is built in, if excessive surge is input, insert a surge protective Zener diode : ZD.



(Fig.1)

### (4) Design of heat sink

Thermal resistance :  $\theta_{j-T}$  of the package of this IC can be obtained from (Fig.2) according to the following expression :

$$\theta_{j-T} = \frac{150^{\circ}\text{C} - 75^{\circ}\text{C}}{15\text{W}} = 5^{\circ}\text{C/W}$$
(Terminal from the junction to the TAB)... Expression ①

Thermal resistance :  $\theta_{HS}$  of the heat sink attached to this IC is decided by the following expression :

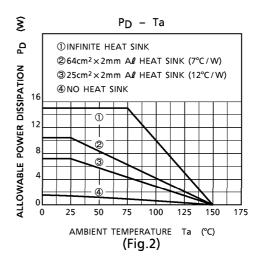
$$\theta_{HS} = \frac{T_j \text{ MAX} - Ta}{P_D \text{ MAX}} - \theta_{j-T} \cdots \text{ Expression } ②$$

Where, P<sub>D</sub> MAX expresses maximum power dissipation in this IC.

PD MAX =

 $(V_{IN} (MAX) - V_{OUT} (MIN)) \times (I1, I6, I7 + I5 + I_B (MAX))$ ... Expression ③

For instance, if this IC is used under the conditions of  $V_{IN}$  (MAX) = 16V, I1 = 300mA, I5 = 100mA and Ta = up to 85°C from Expression ③,



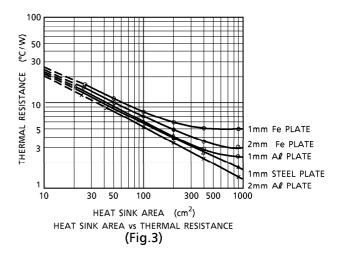
P<sub>D</sub> MAX =  $(16V - 8V) \times (300\text{mA} + 100\text{mA} + 35\text{mA}) = 3.48W$  Substituting P<sub>D</sub> MAX = 3.48W into Expression ②, above,  $\theta_{\text{HS}}$  is obtained as follows :

$$\theta_{HS} = \frac{150^{\circ}\text{C} - 85^{\circ}\text{C}}{3.48\text{W}} - 5^{\circ}\text{C/W} = 13.7^{\circ}\text{C/W}$$

Accordingly, a heat sink having  $\theta_{HS} = 13.7^{\circ}\text{C/W}$  becomes necessary and referring to (Fig.3), it can be set to be an aluminum plate 2mm in thickness and about 270m² in area.

However, when a heat sink is actually mounted to IC, the contact resistance is generated on its contacting surface and heat generated on its contacting surface and heat conduction becomes worse.

Therefore, a heat sink shall be designed with a sufficient margin of heat sink given.



Further, the TAB shall be grounded or kept open when the IC is used.

(5) Output capacitor for preventing the oscillation.

Type and capacity of a capacitor to be used between the output and GND shall be decided after thoroughly examining print pattern, route of connection, at high/low temperature, etc. In particular, if inductor component is connected to the output, it is necessary to make the capacity larger than the recommended value.

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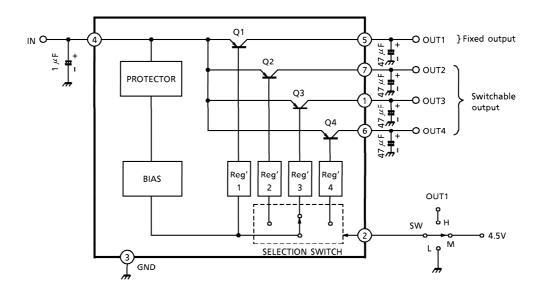
# **MAXIMUM RATINGS** (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Peak Input Voltage (0.2s)	V <sub>IN</sub> (surge)	50	V
DC Input Voltage	VIN (DC)	25	V
Operating Input Voltage	V <sub>IN (opr)</sub>	18	V
Power Dissipation	PD	15	W
Operating Temperature	T <sub>opr</sub>	<b>- 30∼85</b>	°C
Storage Temperature	T <sub>stg</sub>	<b>- 55∼150</b>	°C

# **ELECTRICAL CHARACTERISTICS** (Unless otherwise specified, $V_{IN} = 13.2V$ , Ta = 25°C)

CHARACTE	RISTIC	SYMBOL	TEST CIR- CUIT	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Output (Voltage (	OUT1	V5		I5 = 100mA	8.0	8.3	8.6	V
	OUT2	V7		I7 = 100mA	8.0	8.3	8.6	
	OUT3	V1		I1 = 300mA	8.0	8.3	8.6	
	OUT4	V6		I6 = 100mA	8.0	8.3	8.6	
Bias Current		ΙΒ		15, 7, 1, 6 = 0	_	12	35	mA
Input Variation		∆V <sub>o1</sub>		V <sub>IN</sub> = 9.3~18V I5, 7, 6 = 100mA, I1 = 300mA	_	_	± 50	mV
Load Variation		∆V <sub>o2</sub>	_	I5, 7, 6 = 0~100mA I1 = 0~300mA	_	_	± 50	mV
Input-Output V Difference	oltage	V <sub>DIF</sub>		I5, 7, 6 = 100mA, I1 = 300mA	_	0.3	0.6	٧
Ripple Rejection	n Ratio	R.R.		f = 100Hz, V <sub>ripple</sub> = 0.775V <sub>rms</sub> (0dBm) 15, 7, 6 = 100mA, I1 = 300mA	50	65	_	dB
Max. Output Current	OUT 1, 2, 4	IMAX 5, 7, 6	l	_	100	_	_	mA
	OUT3	IMAX 1	l	_	300		_	
Output Voltage Temperature Co		TC <sub>VO</sub>		I5, 7, 6 = 100mA, I1 = 300mA	_	+ 1	_	mV / deg
Control Termin Resistance	al Input	RCONT	_	_	6	10	_	kΩ
Control Voltage		VH		V6 (OUT4) : ON Ta = -30	7.0	_	VIN	
		٧M		V1 (OUT3) : ON ~80°C	2.8		5.5	V
		VL	_	V7 (OUT2) : ON	0	_	1.2	

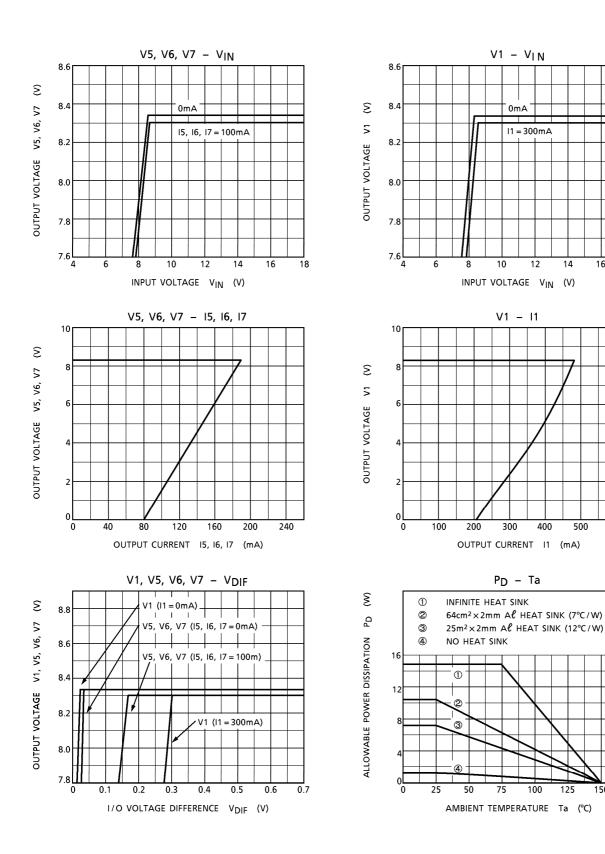
### **TEST CIRCUIT**

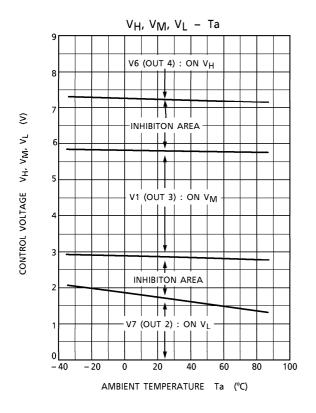


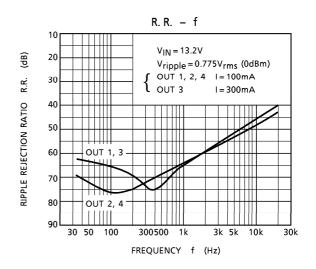
- (Note 1) Heat sink must be used with its fin grounded or in "open" status.
- (Note 2) When inductor element is connected to output, increase the capacity value of oscillation stop capacitor between output and GND.

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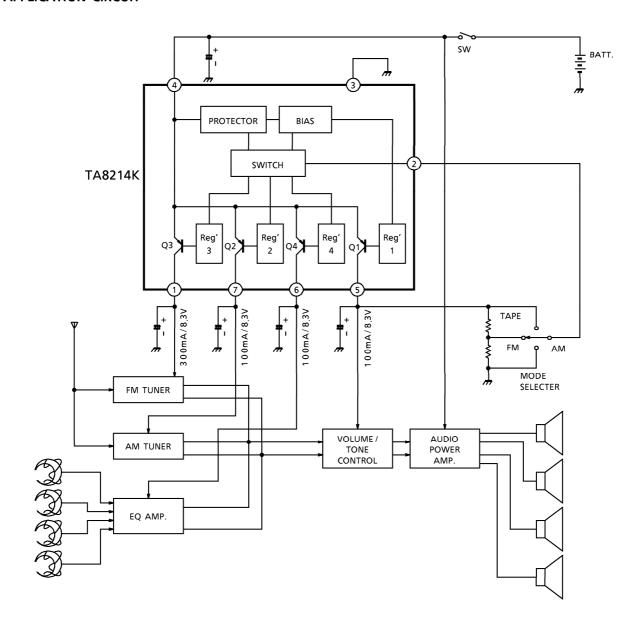
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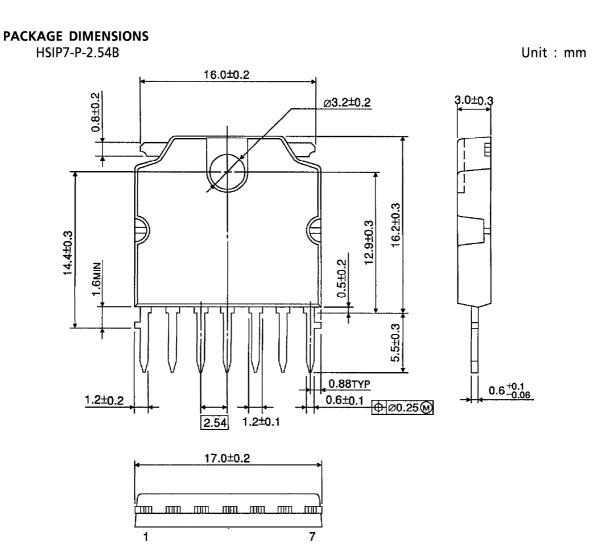






### **APPLICATION CIRCUIT**





Weight: 2.19g (Typ.)

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